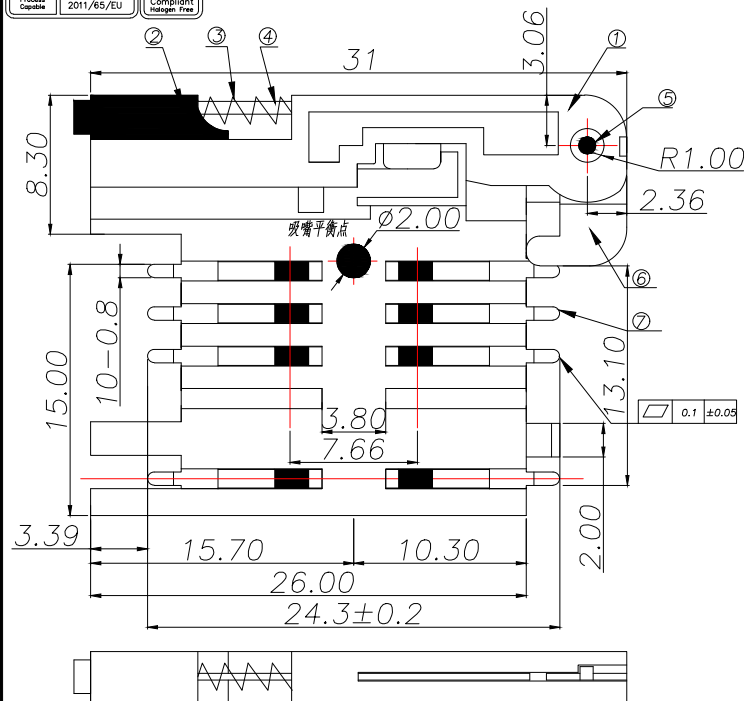
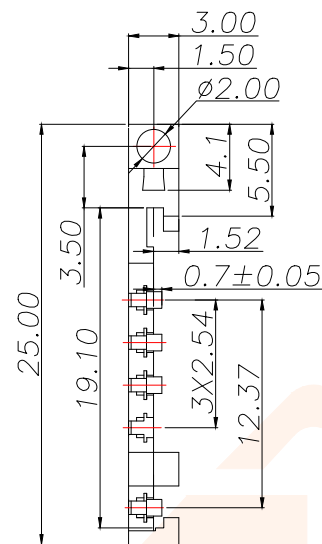


REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



插卡方向
焊脚朝下



Cato model	Tray type
BSIM-021-KT1	MINI SIM
BSIM-021-KT2	NANO SIM
BSIM-021-KT3	Micro SIM

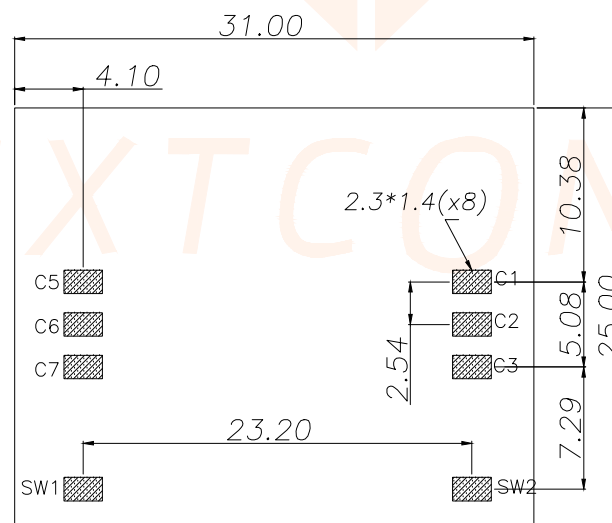
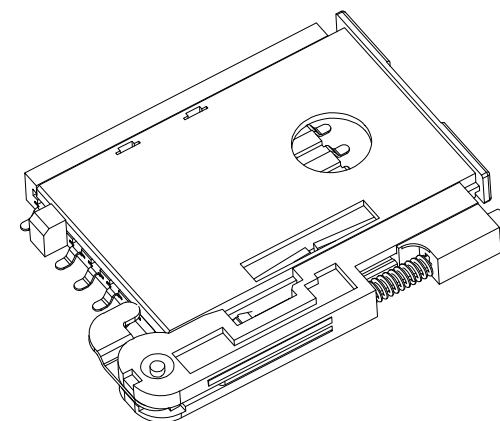
MINI SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
SW1	DETECTION SWITCH1
SW2	DETECTION SWITCH2

技术要求:

- 产品外观无脏污,刮伤,变形现象
- 塑体无毛边,未射饱;端子无氧化,生锈现象

备注:

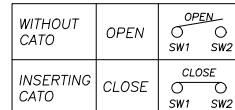
簧片镀金层的厚度可根据客户的需求做变更
建议:卡托过完炉(260°),不能马上插卡,请等待半小时后冷却完成,再插卡测试.



PAD AREA
KEEP OUT AREA

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

Circuit Diagram for Detect Switch

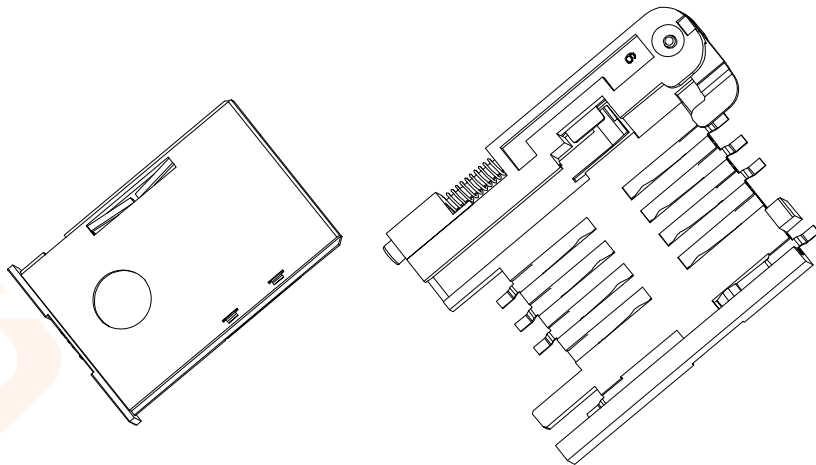
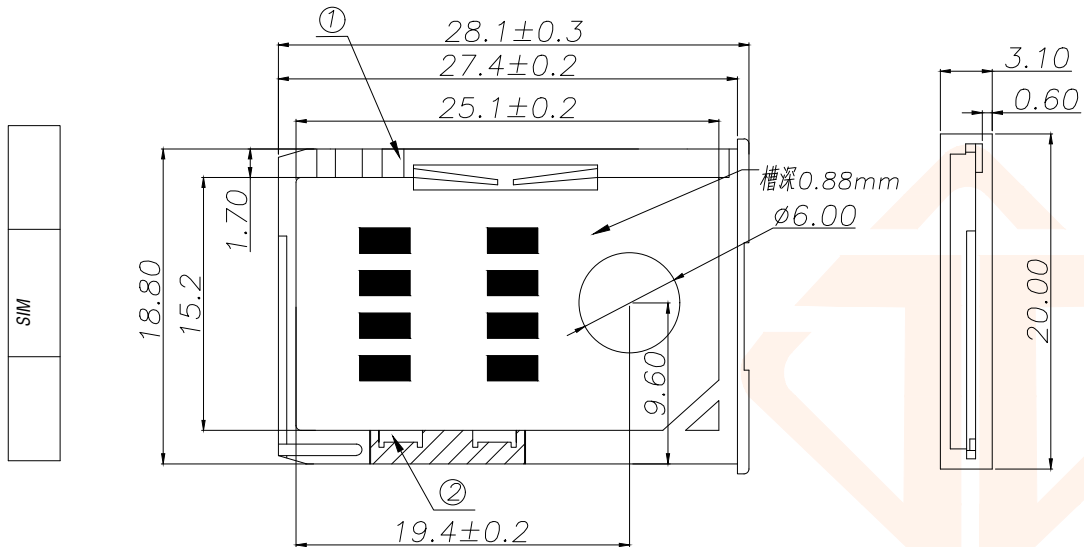


7	簧片	磷铜	8	底层镀Ni;表面局部镀Au
6	Z形片	不锈钢	1	
5	小轴	黄铜	1	
4	推杆	锰钢	1	
3	弹簧	不锈钢	1	
2	按钮	LCP	1	
1	支架	LCP/PPS	1	手工焊:材料为PPS 波峰焊:材料为LCP
序号	名称	材料	数量	备注

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd		
X.X:±0.35	X.X':±3"	PART NO. JXT-BSIM-121-8P	TITLE: MINI SIM CARD 6+2P 推杆式	
X.XX:±0.25	X.XX':±2"			
X.XXX:±0.15		DESIGN: Ethan	MANUFACTURE DWG	
UNITS	mm			
MATERILA	---	CHED: Olvia	SCALE N:A	SHEET 1/5
FINISH	---	APPD: Ava		

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN

适配 MINI SIM 卡



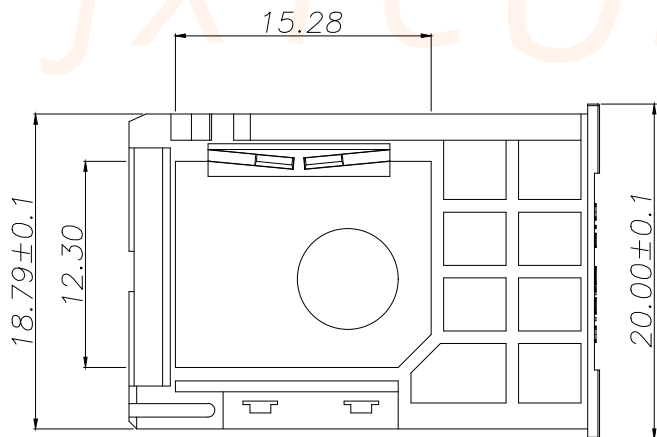
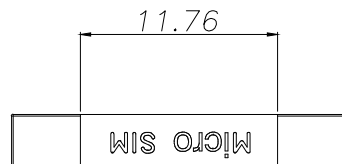
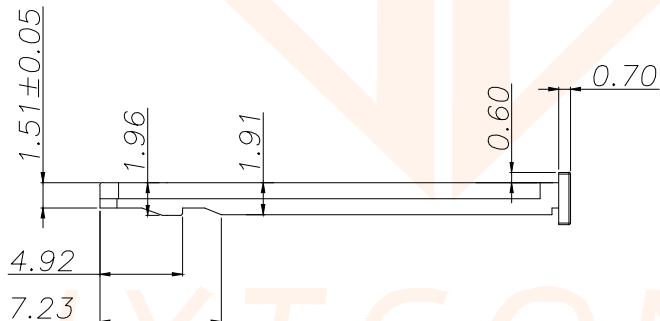
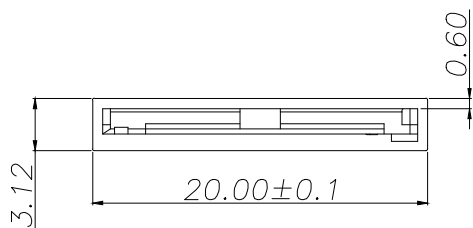
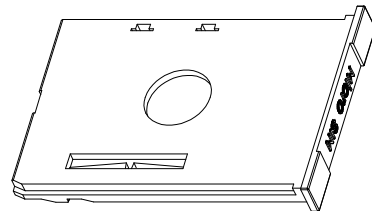
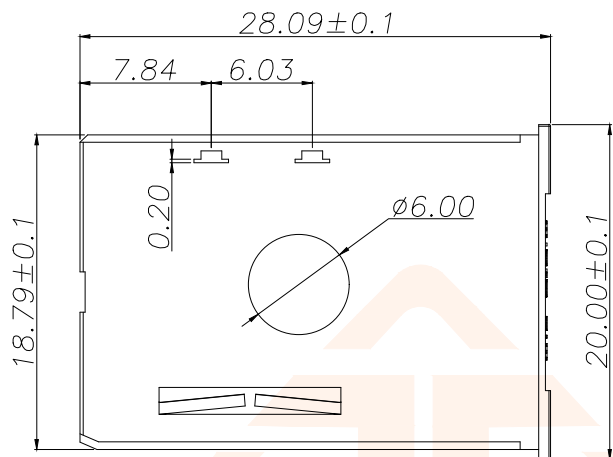
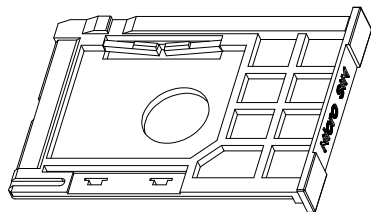
技术要求:

1. 产品外观无脏污, 刮伤, 变形现象
 2. 塑体无毛边, 未射饱; 接触片无氧化, 生锈现象
- 建议: 卡托过完炉 (260°), 不能马上插卡, 请等待半小时后冷却完成, 再插卡测试。

2	接触片	磷铜	1	底层Ni≥100μ", 表层Au, 厚度为≥15μ"
1	抽屉	PC	1	
序号	名称	材料	数量	备注

TOLERANCE		 深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
X.X:±0.35	X.X':±3"	PART NO.	TITLE:		
X.XX:±0.25	X.XX':±2"	JXT-BSIM-121-KT1	MINI SIM		
X.XXX:±0.15		DESIGN: Ethan	MANUFACTURE DWG		
UNITS	mm	CHED: Olivia		SCALE	SHEET
MATERILA	— — —	APPD: Ava		N:A	2/5

适配Micro SIM卡

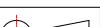


技术要求:

1. 产品外观无脏污, 刮伤, 变形现象
2. 塑体无毛边, 未射饱; 接触片无氧化, 生锈现象

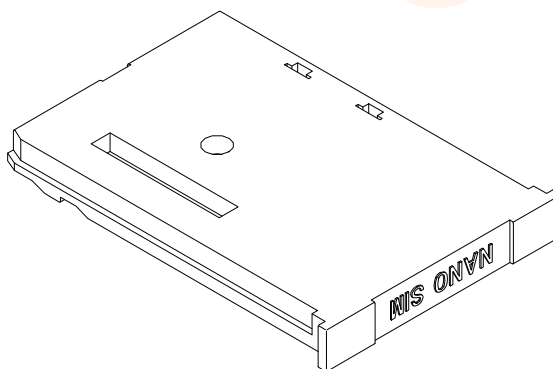
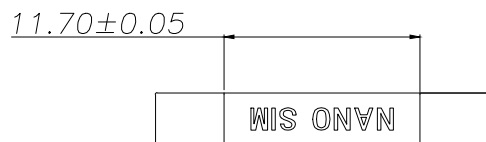
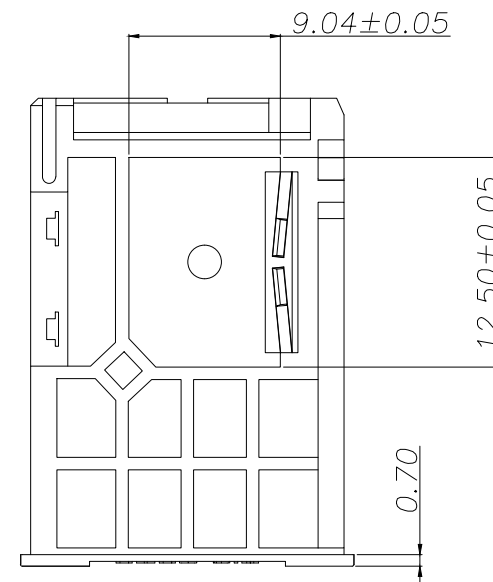
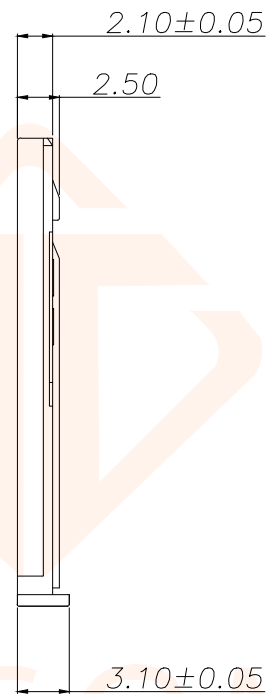
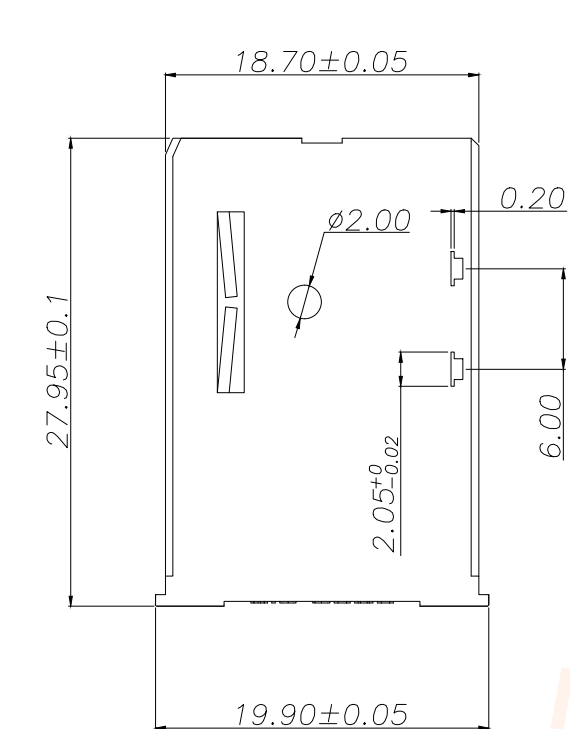
备注: 接触片镀金层的厚度可根据客户的需求做变更

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd				
X.X:±0.35	X.X':±3"	PART NO.		TITLE:		
X.XX:±0.25	X.XX':±2"	JXT-BSIM-121-KT2		Micro SIM		
X.XXX:±0.15		DESIGN: Ethan		MANUFACTURE DWG		
UNITS	mm	CHED: Olvia			SCALE	SHEET
MATERILA	— — —	APPD: Ava			N:A	3/5

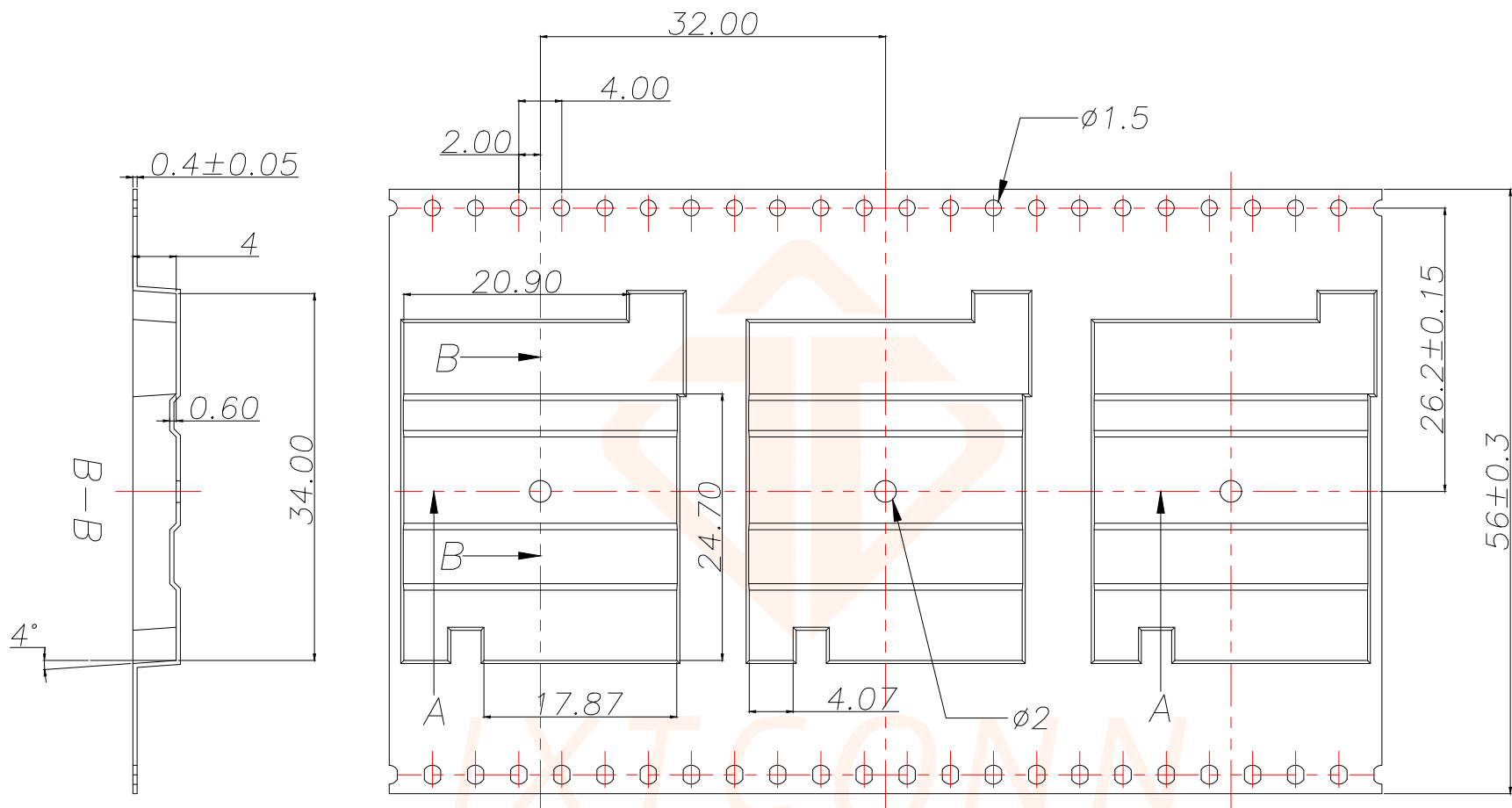
适配NANO SIM卡

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
X.X:±0.35	X.X':±3°	PART NO. JXT-BSIM-121-KT3	TITLE: NANO SIM		
X.XX:±0.25	X.XX':±2°				
X.XXX:±0.15					
UNITS	mm	DESIGN: Ethan	MANUFACTURE DWG		
MATERILA	— — —	CHED: Olvia			
FINISH	— — —	APPD: Ava			
				SCALE N:A	SHEET 4/5

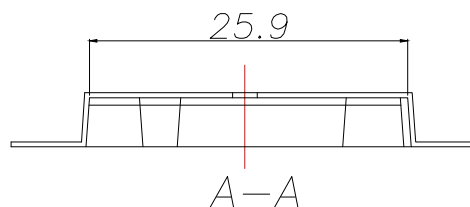
REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



注:

1. 载带 10 个边孔公差累计不能超过 $\pm 0.2\text{mm}$.
2. 表面: 表面平整无凹凸, 无毛屑.
3. 弯曲度: 直尺测量任意 1m, 弯曲度不超 3mm.
4. 韧性: 反复对折后, 侧面无缺口.
5. 材料: 黑色导电 PS.

卷轮包装零件总颗数: 510 颗. (实际包装零件颗数: 500 颗).



TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd		
X.X: ±0.35	X.X': ±3°	PART NO. JXT-BSIM-121-8P	TITLE: MINI SIM CARD 6+2P 推杆式 包装图	
X.XX: ±0.25	X.XX': ±2°			
X.XXX: ±0.15				
UNITS	mm	DESIGN: Ethan	MANUFACTURE DWG	
MATERILA	---	CHED: Olvia		
FINISH	---	APPD: Ava		
			SCALE N:A	SHEET 5/5